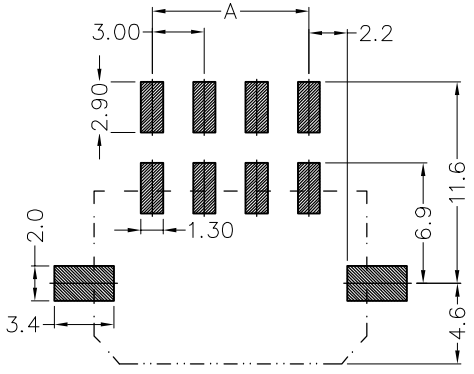
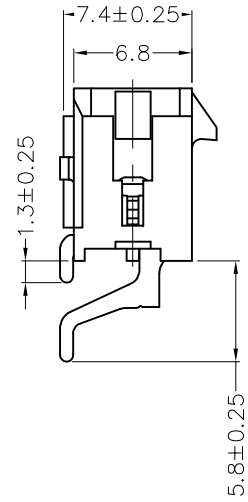
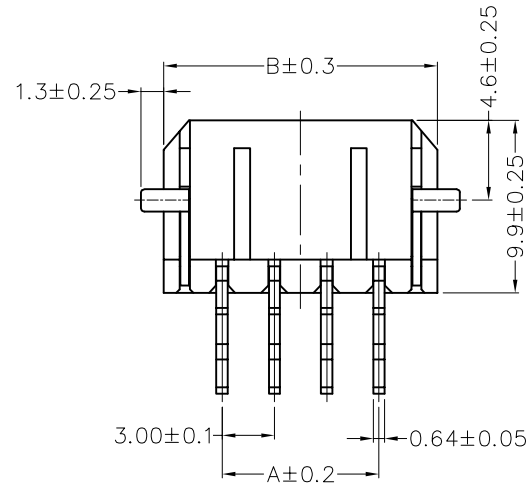
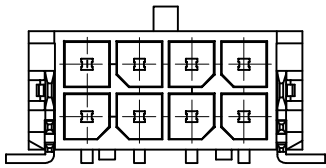


1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD



Recommended P.C.Board Layout
Tolerances: ±0.05

SPECIFICATIONS

Electrical
 Current Rating: 5.0A AC(rms)/DC
 Voltage Rating: 250V AC(rms)/DC
 Contact Resistance: 10 mΩ Max
 Insulation Resistance: 1000 MΩ Min
 Withstanding Voltage: 1000V AC r.m.s
 Temperature Range—Operating: -25°C~+85°C

Material and Plating
 Housing: PA9T (UL 94V-0), Black
 Contact: Brass, Tin plated
 Solder tab: Brass, Tin plated

Ordering Information

FWF	300	26	—	D	XX	B	2	5	BK	M
1	2	3	4	5	6	7	8	9	10	
1	2	3	4	5	6	7	8	9	10	
Category	Series Number	Distinction No.	Row Option	Circuits	Entry Angle	Plating	Material-Resin	Color-Resin	Packaging	
FWF-Wafer	300-Pitch3.00mm	26	D-Double row	XX	B-90° Angle	2-Tin Plated	5-PA9T	BK-Black	M-Reel	

<p>THIRD ANGLE PROJECTION</p>	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY	DATE	PART NO.	ITEM NO.	<p>Leader Of Industry</p>
	X. ±0.30	X.* ±5°	FRANK	20/APR/22	FWF30026-DXXB25BKM	FWF30026	
DESIGN UNITS Metric	X.X ±0.20	X.X* ±2°	CHECKED BY	DATE	TITLE		REV 0
SCALE 5:1	X.XX ±0.15	X.XX* ±1°	CHERRY	20/APR/22	Wire to Board (Wafer) Pitch 3mm 90° Angle (SMT)		SHEET NO. 1/2
SIZE A4	X.XXX ±0.10	X.XXX* ±0.5°	DRAWN BY	DATE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
			MATT	20/APR/22			

1 2 3 4 5 6 7 8

1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

A

B



C

D

E

F

Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF30026-D02B25BKM	-	6.65
4	FWF30026-D04B25BKM	3.00	9.65
6	FWF30026-D06B25BKM	6.00	12.65
8	FWF30026-D08B25BKM	9.00	15.65
10	FWF30026-D10B25BKM	12.00	18.65
12	FWF30026-D12B25BKM	15.00	21.65
14	FWF30026-D14B25BKM	18.00	24.65
16	FWF30026-D16B25BKM	21.00	27.65
18	FWF30026-D18B25BKM	24.00	30.65
20	FWF30026-D20B25BKM	27.00	33.65
22	FWF30026-D22B25BKM	30.00	36.65
24	FWF30026-D24B25BKM	33.00	39.65

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 20/APR/22	PART NO. FWF30026-DXXB25BKM	ITEM NO. FWF30026	 Leader Of Industry	
	DESIGN UNITS Metric	X. ±0.30 X.X ±0.20 X.XX ±0.15 X.XXX ±0.10	X.* ±5° X.X* ±2° X.XX* ±1° X.XXX* ±0.5°	CHECKED BY CHERRY	DATE 20/APR/22	TITLE Wire to Board (Wafer) Pitch 3mm 90° Angle (SMT)		
SCALE 5:1	SIZE A4	DRAWN BY MATT		DATE 20/APR/22	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		REV 0	SHEET NO. 2/2

1 2 3 4 5 6 7 8